

Mosfet

Metal Oxide Semiconductor Field Effect Transistor

OptiMOS™ Power-Transistor, -30V

BSL303SPE

Data Sheet

Rev. 2.0
Final

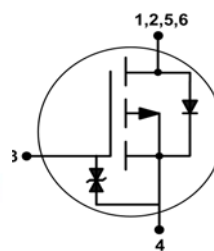
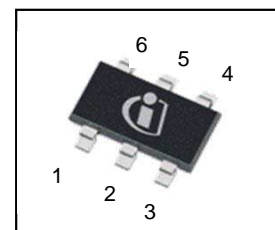
Industrial & Multimarket

OptiMOS™-P 3 Small-Signal-Transistor
Features

- P-channel
- Enhancement mode
- Logic level (4.5V rated)
- ESD protected
- Avalanche rated
- Qualified according to AEC Q101
- 100% Lead-free; RoHS compliant, halogen free


Product Summary

| | | |
|------------------|------------------------|----|
| V_{DS} | -30 | V |
| $R_{DS(on),max}$ | $V_{GS}=-10\text{ V}$ | 33 |
| | $V_{GS}=-4.5\text{ V}$ | 52 |
| I_D | -6.3 | A |


PG-TSOP-6


| Type | Package | Tape and Reel Information | Marking | Hal. Free | Packing |
|-----------|-----------|---------------------------|---------|-----------|---------|
| BSL303SPE | PG-TSOP-6 | H6327: 3000 pcs/ reel | sPV | Yes | Non dry |

Maximum ratings, at $T_j=25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|-------------------------------------|-------------------|--|------------------------|--------------------|
| Continuous drain current | I_D | $T_A=25\text{ °C}$ | -6.3 | A |
| | | $T_A=70\text{ °C}$ | -5.0 | |
| Pulsed drain current | $I_{D,pulse}$ | $T_A=25\text{ °C}$ | -25.2 | |
| Avalanche energy, single pulse | E_{AS} | $I_D=-6.3\text{ A}$, $R_{GS}=25\ \Omega$ | 30.0 | mJ |
| Reverse diode dv/dt | dv/dt | $I_D=-6.3\text{ A}$, $V_{DS}=-15\text{ V}$, $di/dt=100\text{ A}/\mu\text{s}$, $T_{j,max}=150\text{ °C}$ | 6 | kV/ μs |
| Gate source voltage | V_{GS} | | ± 20 | V |
| Power dissipation | P_{tot} | $T_A=25\text{ °C}$ | 2.0 | W |
| Operating and storage temperature | T_j , T_{stg} | | -55 ... 150 | $^{\circ}\text{C}$ |
| ESD Class | | JESD22-A114 -HBM | 2 (2kV to 4kV) | V |
| Soldering Temperature | | | 260 $^{\circ}\text{C}$ | $^{\circ}\text{C}$ |
| IEC climatic category; DIN IEC 68-1 | | | 55/150/56 | $^{\circ}\text{C}$ |

| Parameter | Symbol | Conditions | Values | | | Unit |
|-----------|--------|------------|--------|------|------|------|
| | | | min. | typ. | max. | |

Thermal characteristics

| | | | | | | |
|--|------------|--|---|---|------|-----|
| Thermal resistance, junction - minimal footprint | R_{thJS} | | - | - | 50 | K/W |
| SMD version, device on PCB | R_{thJA} | minimal footprint | - | - | 230 | |
| | | 6 cm ² cooling area ¹⁾ | - | - | 62.5 | |

Electrical characteristics, at $T_j=25\text{ °C}$, unless otherwise specified
Static characteristics

| | | | | | | |
|----------------------------------|---------------|---|-----|------|------|------------|
| Drain-source breakdown voltage | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=-250\mu A$ | -30 | - | - | V |
| Gate threshold voltage | $V_{GS(th)}$ | $V_{DS}=0V, I_D=-30\mu A$ | -2 | -1.5 | -1 | |
| Drain-source leakage current | I_{DSS} | $V_{DS}=-30V, V_{GS}=0V, T_j=25\text{ °C}$ | - | - | -0.1 | μA |
| | | $V_{DS}=-30V, V_{GS}=0V, T_j=150\text{ °C}$ | - | - | -20 | |
| Gate-source leakage current | I_{GSS} | $V_{GS}=-20V, V_{DS}=0V$ | - | - | -7 | μA |
| Drain-source on-state resistance | $R_{DS(on)}$ | $V_{GS}=-4.5V, I_D=-5A$ | - | 35 | 52 | m Ω |
| | | $V_{GS}=-10V, I_D=-6.3A$ | - | 25 | 33 | |
| Transconductance | g_{fs} | $ V_{DS} >2 I_D R_{DS(on)max}, I_D=-5A$ | | 12.9 | - | S |

¹⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (single layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air. ($t < 5$ sec.)

| Parameter | Symbol | Conditions | Values | | | Unit |
|-----------|--------|------------|--------|------|------|------|
| | | | min. | typ. | max. | |

Dynamic characteristics²⁾

| | | | | | | |
|------------------------------|--------------|--|---|------|------|----|
| Input capacitance | C_{iss} | $V_{GS}=0\text{ V}, V_{DS}=-15\text{ V},$ $f=1\text{ MHz}$ | - | 1053 | 1401 | pF |
| Output capacitance | C_{oss} | | - | 482 | 641 | |
| Reverse transfer capacitance | C_{rss} | | - | 33 | 50 | |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD}=-15\text{ V}, V_{GS}=-10\text{ V},$ $I_D=-6.3\text{ A},$ $R_{G,ext}=6\ \Omega$ | - | 8.0 | 12 | ns |
| Rise time | t_r | | - | 7.7 | 12 | |
| Turn-off delay time | $t_{d(off)}$ | | - | 23.7 | 36 | |
| Fall time | t_f | | - | 8.3 | 12 | |

Gate Charge Characteristics²⁾

| | | | | | | |
|-----------------------|---------------|--|---|------|------|----|
| Gate to source charge | Q_{gs} | $V_{DD}=-15\text{ V}, I_D=-6.3\text{ A},$ $V_{GS}=0\text{ to }-10\text{ V}$ | - | 3.3 | 4.4 | nC |
| Gate to drain charge | Q_{gd} | | - | 1.6 | 2.4 | |
| Gate charge total | Q_g | | - | 14.0 | 20.9 | |
| Gate plateau voltage | $V_{plateau}$ | | - | 3.1 | - | V |

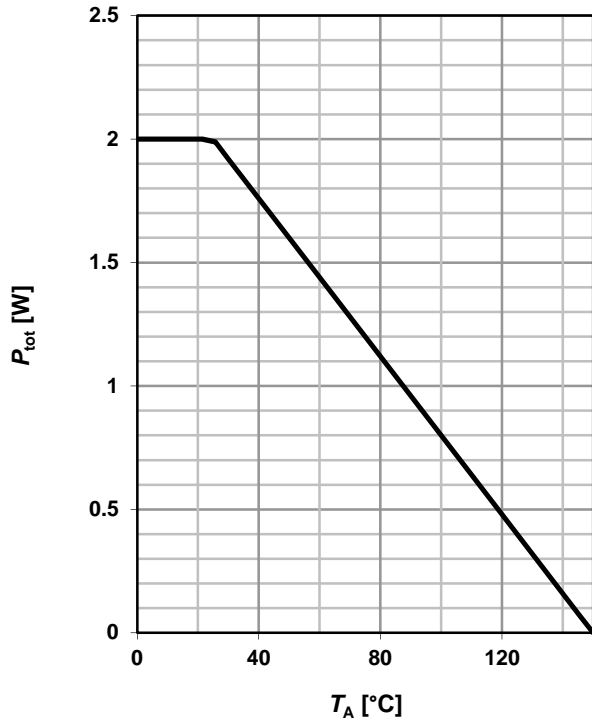
Reverse Diode

| | | | | | | |
|---------------------------------------|---------------|--|---|------|-------|----|
| Diode continuous forward current | I_S | $T_A=25\text{ }^\circ\text{C}$ | - | - | -6.3 | A |
| Diode pulse current | $I_{S,pulse}$ | | - | - | -25.2 | |
| Diode forward voltage | V_{SD} | $V_{GS}=0\text{ V}, I_F=-6.3\text{ A},$ $T_j=25\text{ }^\circ\text{C}$ | - | -0.9 | -1.1 | V |
| Reverse recovery time ²⁾ | t_{rr} | $V_R=-15\text{ V}, I_F=-6.3\text{ A},$ $di_F/dt=100\text{ A}/\mu\text{s}$ | - | 33 | 49 | ns |
| Reverse recovery charge ²⁾ | Q_{rr} | | - | 28 | 43 | nC |

²⁾ Defined by design. Not subjected to production test

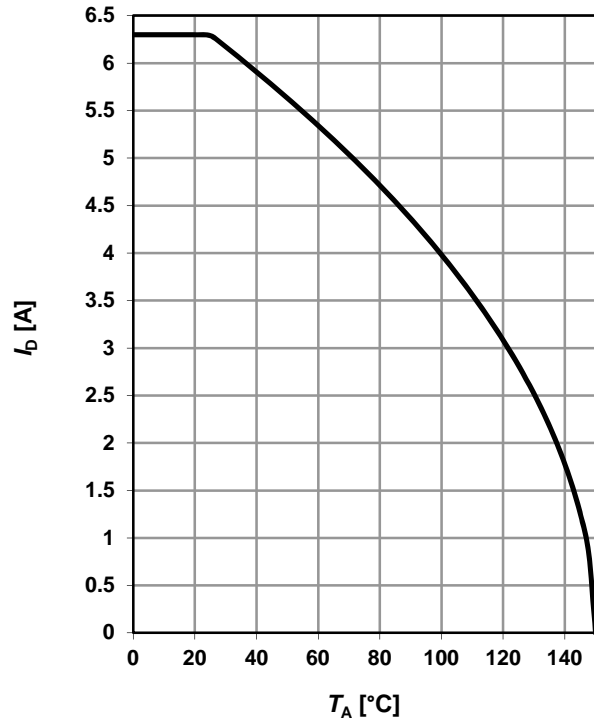
1 Power dissipation

$P_{tot}=f(T_A)$



2 Drain current

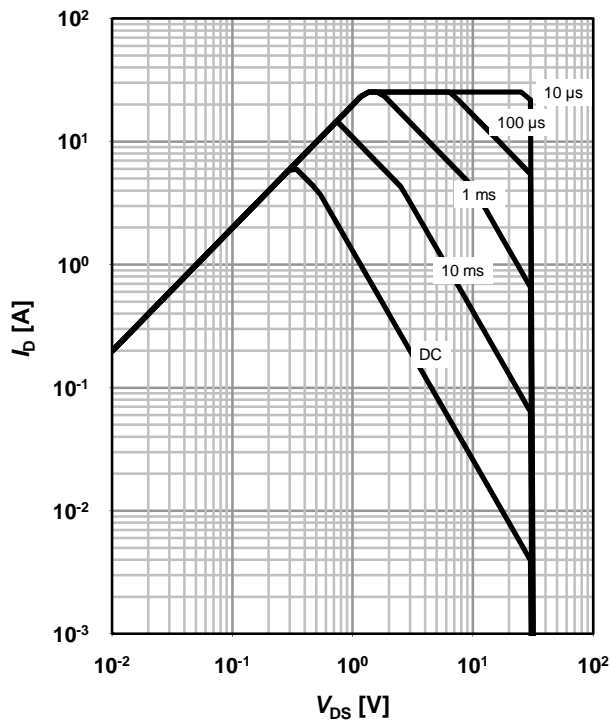
$I_D=f(T_A); V_{GS} \leq -10\text{ V}$



3 Safe operating area

$I_D=f(V_{DS}); T_A=25\text{ °C}; D=0$

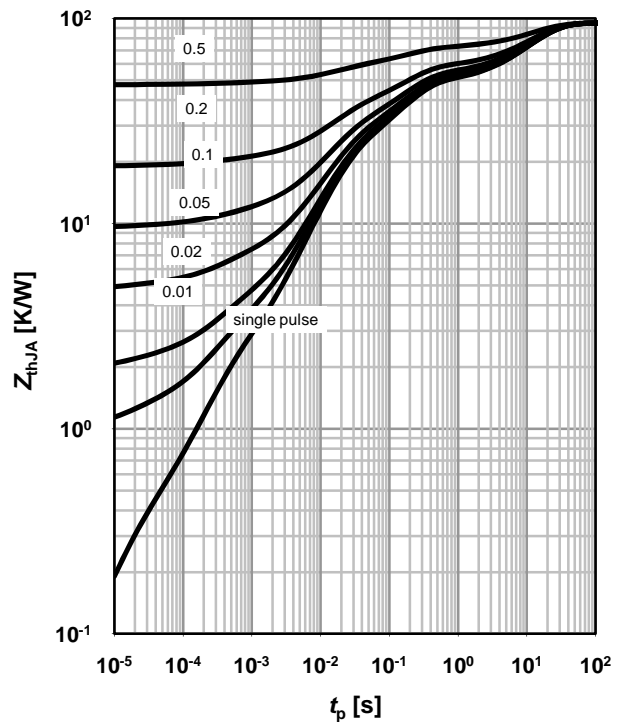
parameter: t_p



4 Max. transient thermal impedance

$Z_{thJA}=f(t_p)$

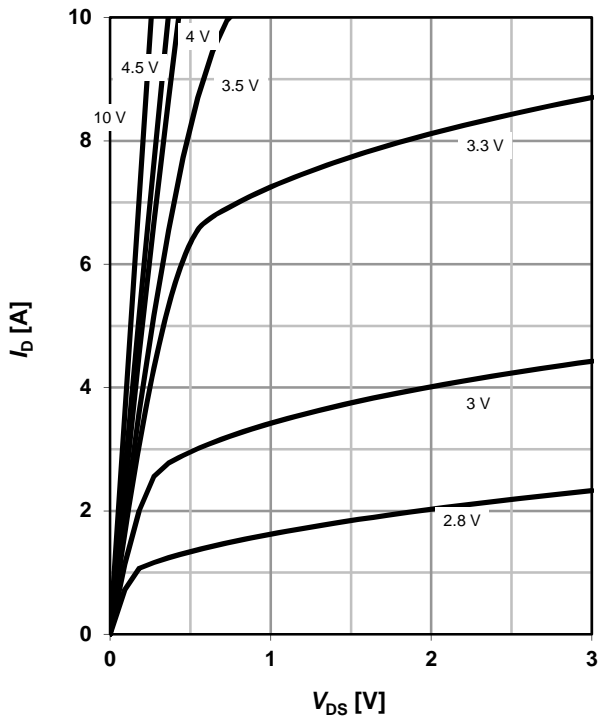
parameter: $D=t_p/T$



5 Typ. output characteristics

$I_D=f(V_{DS}); T_j=25\text{ }^\circ\text{C}$

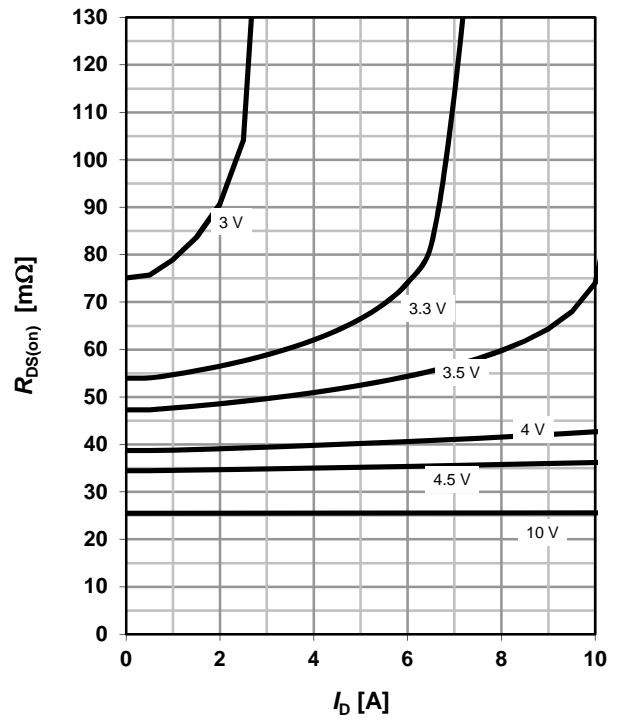
parameter: V_{GS}



6 Typ. drain-source on resistance

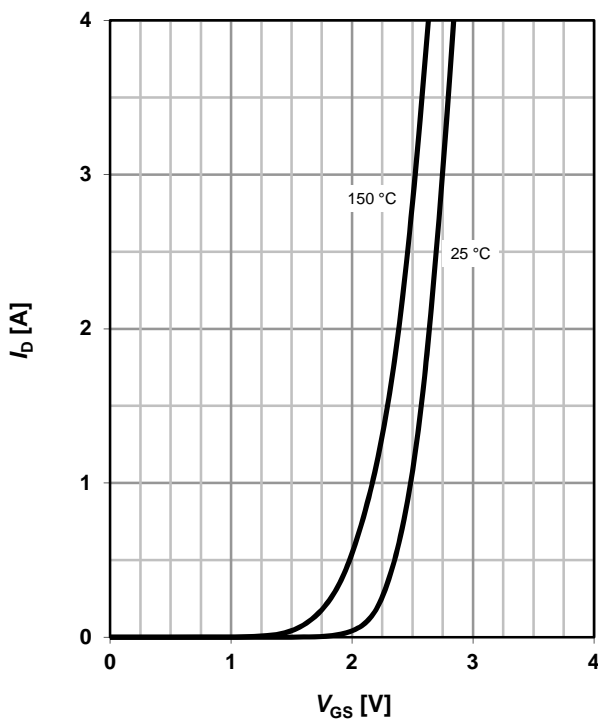
$R_{DS(on)}=f(I_D); T_j=25\text{ }^\circ\text{C}$

parameter: V_{GS}



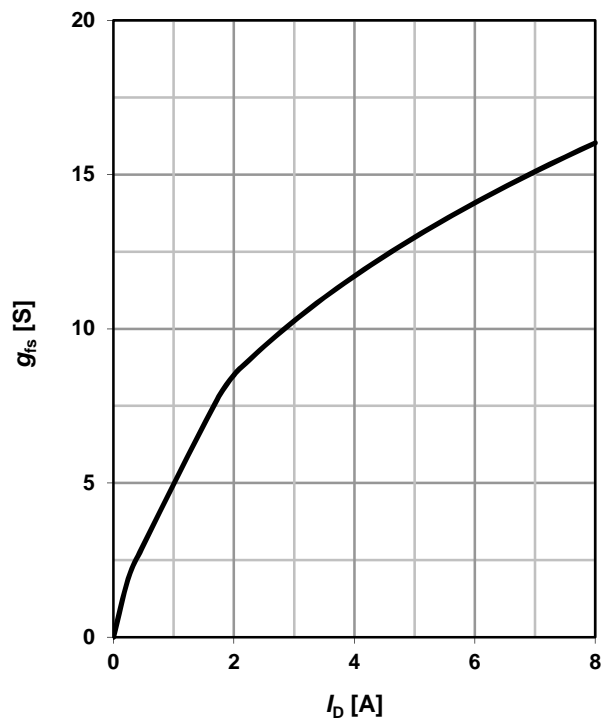
7 Typ. transfer characteristics

$I_D=f(V_{GS}); |V_{DS}|>2|I_D|R_{DS(on)max}$



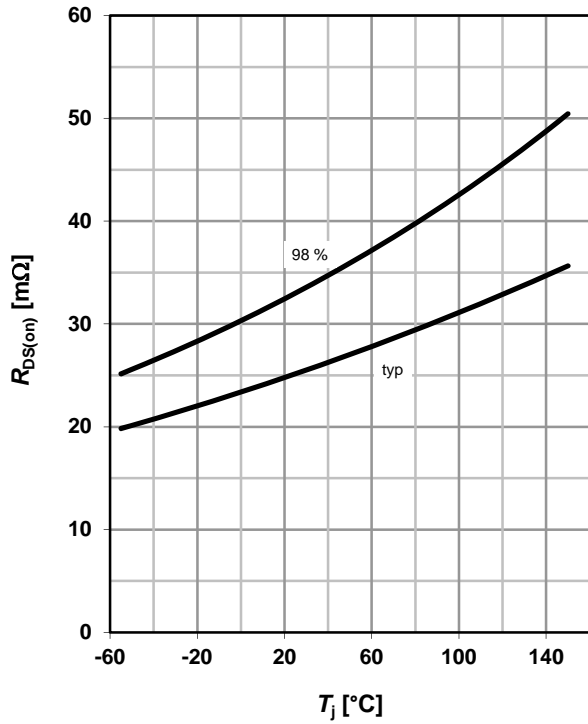
8 Typ. forward transconductance

$g_{fs}=f(I_D); T_j=25\text{ }^\circ\text{C}$



9 Drain-on-state resistance

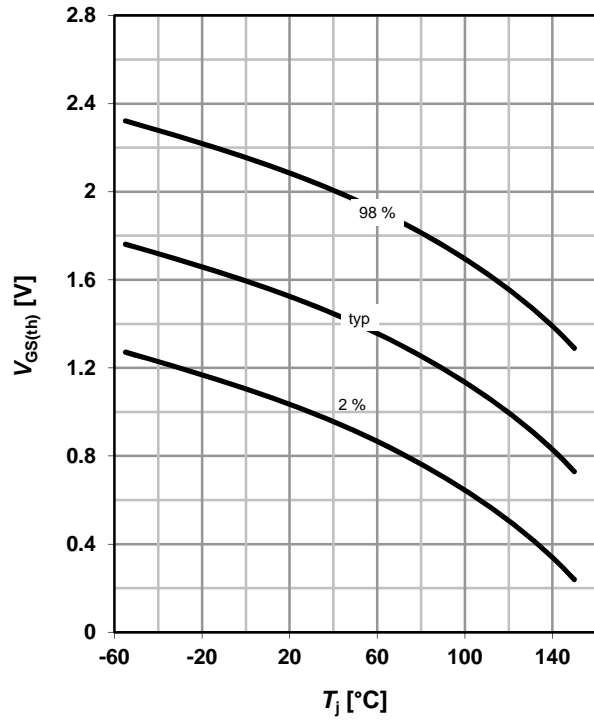
$R_{DS(on)}=f(T_j)$; $I_D=-6.3$ A; $V_{GS}=-10$ V



10 Typ. gate threshold voltage

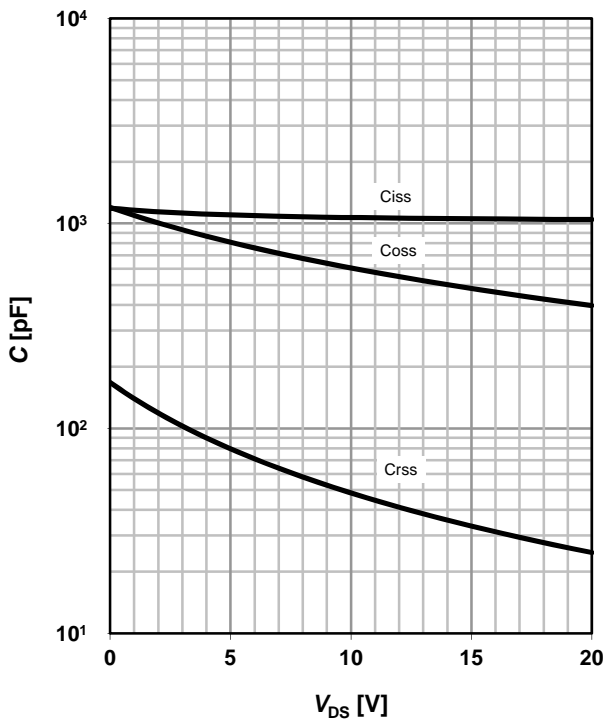
$V_{GS(th)}=f(T_j)$; $V_{DS}=V_{GS}$; $I_D=-30$ μ A

parameter: I_D



11 Typ. capacitances

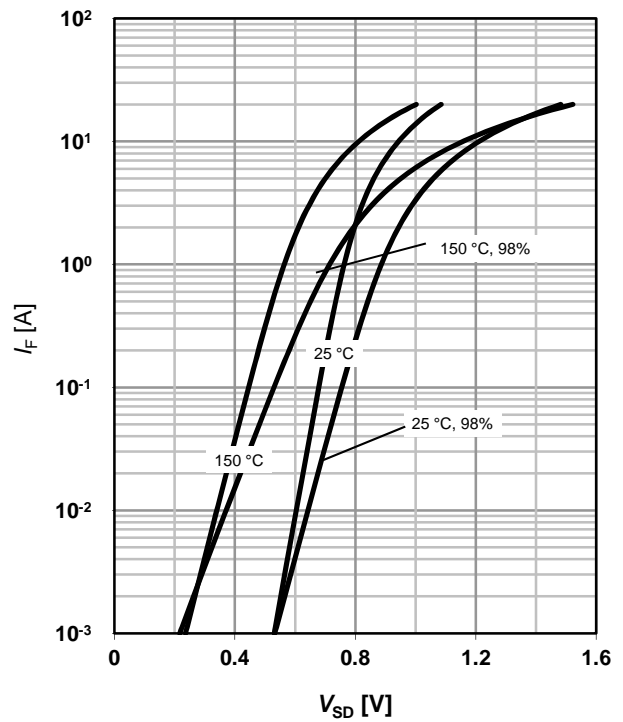
$C=f(V_{DS})$; $V_{GS}=0$ V; $f=1$ MHz; $T_j=25$ °C



12 Forward characteristics of reverse diode

$I_F=f(V_{SD})$

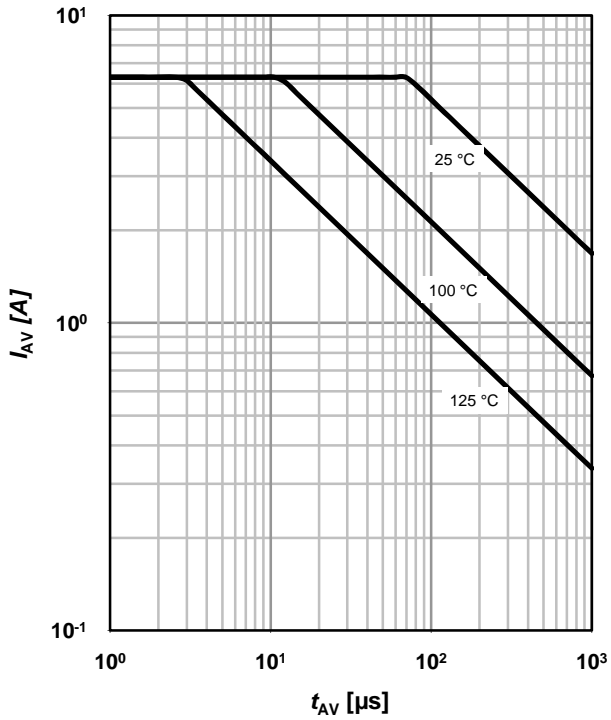
parameter: T_j



13 Avalanche characteristics

$I_{AS}=f(t_{AV}); R_{GS}=25 \Omega$

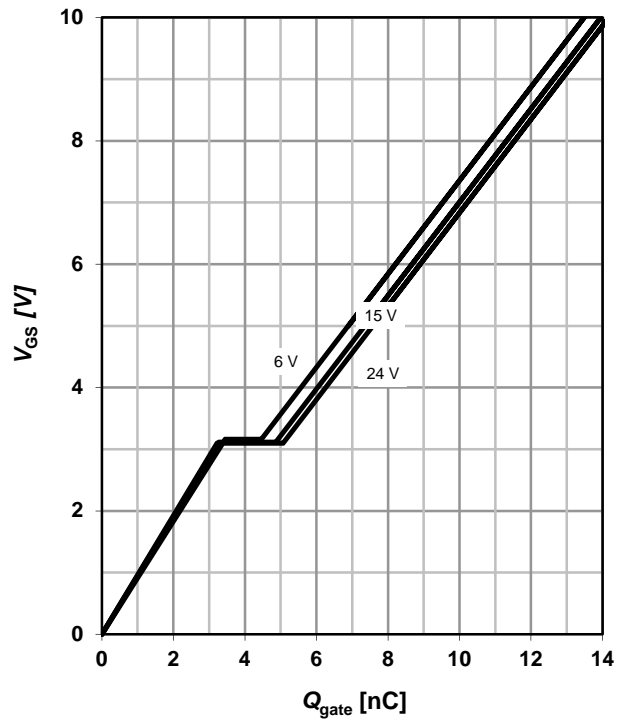
parameter: $T_{j(\text{start})}$



14 Typ. gate charge

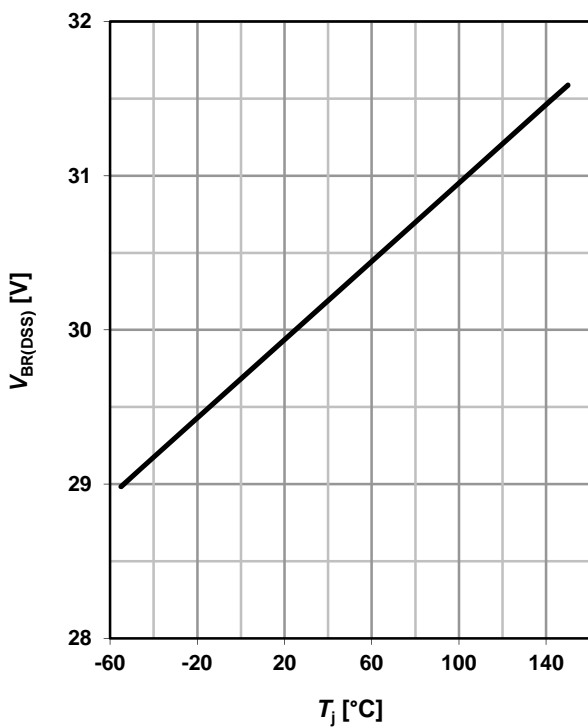
$V_{GS}=f(Q_{\text{gate}}); I_D=-6.3 \text{ A pulsed}$

parameter: V_{DD}

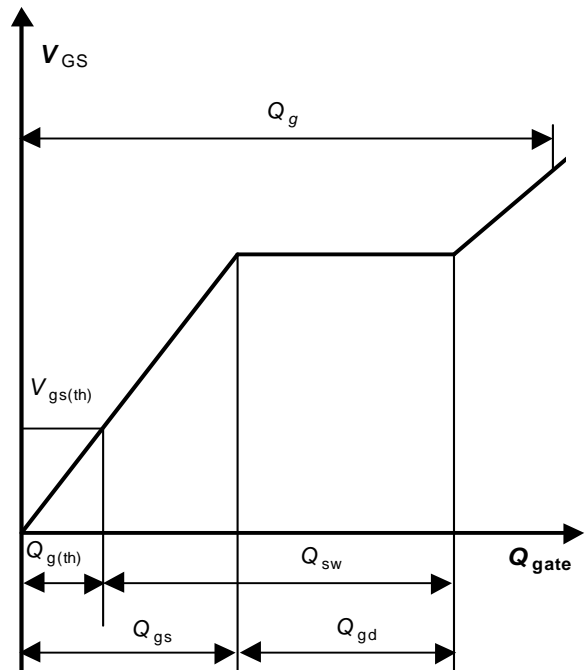


15 Drain-source breakdown voltage

$V_{BR(DSS)}=f(T_j); I_D=-250 \mu\text{A}$

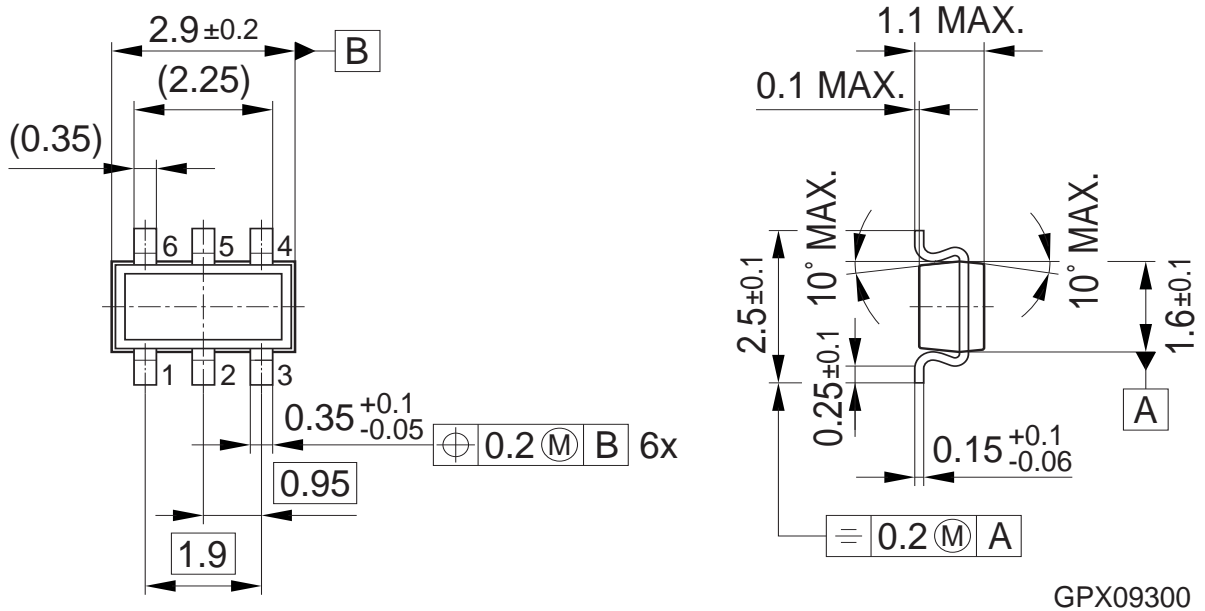


16 Gate charge waveforms



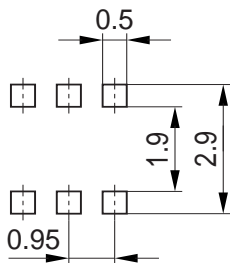
Package Outline:

TSOP-6



GPX09300

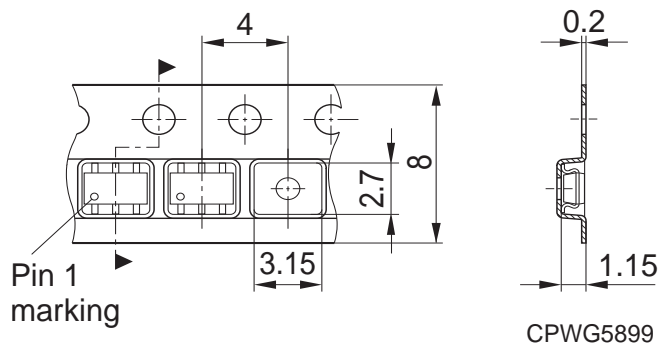
Footprint:



Remark: Wave soldering possible dep. on customers process conditions

HLG09283

Packaging:



CPWG5899

Dimensions in mm

Note: For symmetric types there is no defined Pin 1 orientation in the reel.

Revision History

BSL303SPE

Revision: 2014-12-10, Rev. 2.0

Previous Revision

| Revision | Date | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.0 | 2014-12-10 | Release of final version |

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